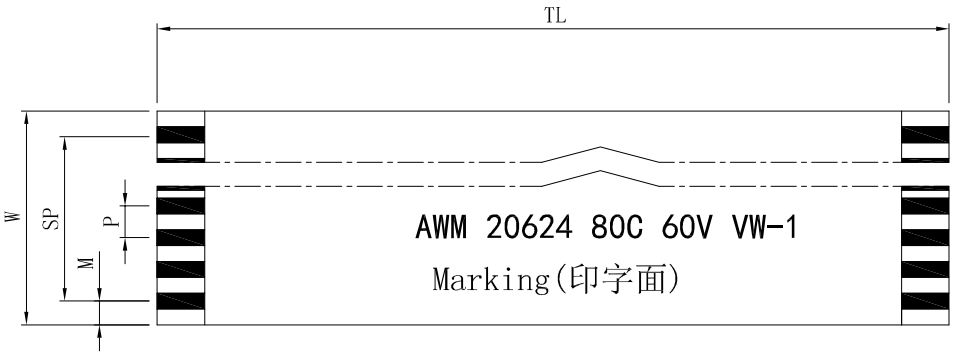
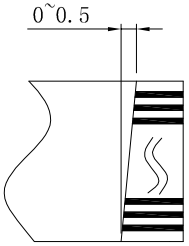
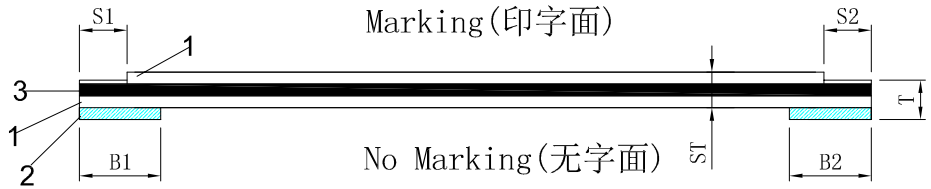
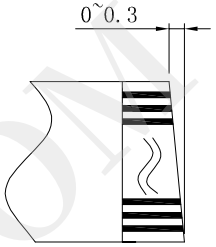
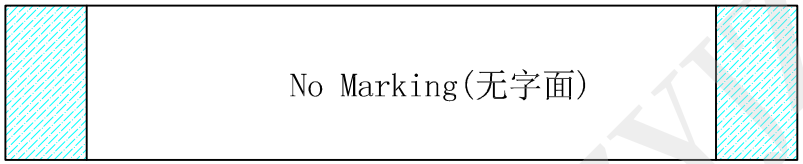










STRUCTURE(构造)				
NO.	ITEM(项目)	SPECIFICATION(规格)		
1	INSULATION (胶膜)	印字：通用版20624(43um)		
		白膜：80℃ 60V(43um)		
2	SUPPORTING TAPE (补强板)	225um		Blue(蓝色)
3	CONDUCTOR (导体)	Thickness(厚度)	0.035	±0.005
		Width(宽度)	0.3	±0.03
	CONDUCTOR (导体镀层)	PLATED(电镀)	锡Sn(40u")	MIN
		PLATED(电镀)	——	——

DIMENSION(尺寸)			
No. of conductors (导体数目)	N	20	
Pitch(间距)	P	0.5	±0.05
Span(总间距)	SP	9.5	±0.05
Width(总宽度)	W	10.5	±0.08
Margin(边缘宽度)	M	0.5	±0.07
Total length(总长度)	TL	50	±2.0
Insert Thickness (插接端厚度)	T	0.30	±0.03
Surface Thickness (线身厚度)	ST	0.12	±0.03
Strip Length (裸铜长度)	S1	3.0	±0.5
	S2	3.0	±0.5
Supporting Tape Length(补强板长度)	B1	5.0	±1.0
	B2	5.0	±1.0

技术要求：
1、保存环境：
温度：15~25℃ 湿度：30~50RH%
2、保质期：
镀金：12个月 镀锡：6个月
3、产品符合RoHS 2.0标准

深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.° ±2° X.X° ±0.5°	DRAWED BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.5*20*50*A(3/3/5/5)(0.035*0.3)
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC-FFCX13
			MOLD NO.
UNIT: mm [inch]	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2310181546
SCALE:1:1 SIZE: A4			SHEET NO. 1 OF 1

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